

IN THE CLAIMS:

Please cancel claims 1-18 without prejudice or disclaimer. ✓

Please amend the claims as follows: ✓

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19. (Amended) A multi-layer substrate structure comprising:
at least one layer having generic electrical features altered to customize said layer,
wherein said electrical features include vias,
wherein said vias are selectively filled with one of a conducting material and an
insulating material.

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22. (Amended) The multi-layer substrate structure in claim 19, further comprising a
second layer similar to said layer and having said generic electrical features altered differently than
said layer to customize said second layer differently than said layer.

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23. (Amended) The multi-layer substrate structure in claim 19, wherein said layer is for
being changes into a plurality of differently customized layers.

24. (Amended) The multi-layer substrate structure in claim 19, wherein said layer
includes a generic grid of vias useful with a plurality of differently customized layers.

25. (Amended) The multi-layer substrate structure in claim 19, wherein said layer
includes a generic pattern of wiring useful with a plurality of differently customized layers.